



Product Change Notification

Change Notification #: 118364-00
Change Title: Select Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack,
PCN 118364-00, Product Discontinuance, End of Life
Date of Publication: July 14, 2021

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	October 10, 2021
Last Product Discontinuance Shipment Date:	January 08, 2022

Description of Change to the Customer:

The Intel SKU listed in the products affected table will End of life

Customer Impact of Change and Recommended Action:

Please determine your remaining demand for the products listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above.

Intel will make commercially reasonable efforts to support last time order quantities for Intel® SSD 660p Series. However, due to supply limitations, customer orders may be fulfilled from the replacement products listed in the table above.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	Affected MM#
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW020T801	976804

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
July 14, 2021	00	Originally Published PCN



Product Change Notification

118364-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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